



1.0A SURFACE MOUNT ULTRA-FAST RECTIFIER

Product Summary (@ TA = +25°C)

V _{RRM} (V)	I _O (A)	V _F Max (V)	I _R Max (μA)
600,1000	1	1.7	5

Description

The US1JDF and US1MDF are rectifiers packaged in the low profile D-FLAT package. Providing ultra-fast recovery time for high efficiency, this device is ideal for use in general rectification applications.

Applications

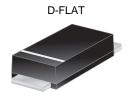
- Switching Mode Power Supply
- DC-DC Converter

Features and Benefits

- Glass Passivated Die Construction
- Ultra-Fast Recovery Time for High Efficiency
- Surge Overload Rating to 30A Peak
- High Current Capability
- Low Profile Design, Package Height Less than 1.1mm
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

- Case: D-FLAT
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Polarity: Cathode Band
- Weight: 0.035 grams (Approximate)



Top View

Ordering Information (Note 4)

Part Number	Qualification	Case	Packaging
US1JDF-13	Commercial	D-FLAT	10,000/Tape & Reel
US1MDF-13	Commercial	D-FLAT	10,000/Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + CI) and https://www.diodes.com/products/packages.html.
 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html

Marking Information



U1J or U1M = Product Type Marking Code □ = Manufacturers' Code Marking YWW = Date Code Marking Y = Last Digit of Year (ex: 6 for 2016) WW = Week Code (01 to 53) AB = Foundry and Assembly Code



Maximum Ratings ($@T_A = +25^{\circ}C$, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitance load, derate current by 20%.

Characteristic	Symbol	US1JDF	US1MDF	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage (Note 5)	V _{RRM} V _{RWM} V _R	600	1,000	V
RMS Reverse Voltage	V _{R(RMS)}	420	700	V
Average Rectified Output Current @T _T = +25°C	Io	1.	0	Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	30)	Α

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance, Junction to Terminal (Note 8)	$R_{\theta JT}$	44	°C/W
Typical Thermal Resistance, Junction to Ambient (Note 8)	$R_{\theta JA}$	80	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

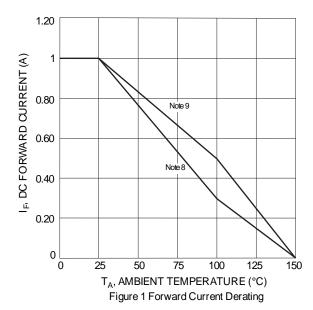
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

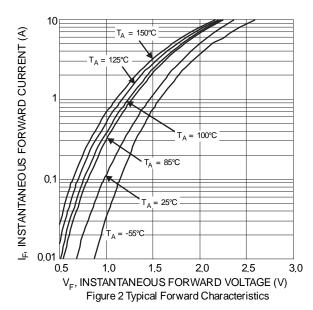
Characteristic		Symbol	US1JDF	US1MDF	Unit
Minimum Reverse Breakdown Voltage (Note 5)	$@I_R = 5\mu A$	$V_{(BR)R}$	600	1,000	V
Maximum Forward Voltage Drop	$@ I_F = 1.0A$	V_{F}	1.	7	V
Peak Reverse Current	@T _A = +25°C		5.	0	μA
at Rated DC Blocking Voltage (Note 5)	$@T_A = +100^{\circ}C$	IR	10	00	μA
Maximum Reverse Recovery Time (Note 6)		t _{RR}	7:	5	ns
Typical Total Capacitance (Note 7)		Ст	1	0	pF

Notes:

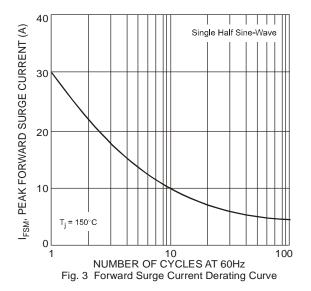
- 5. Short duration pulse test used to minimize self-heating effect.
- 6. Measured with $I_F = 0.5A$, $I_R = 1.0A$, $I_{RR} = 0.25A$. See figure 7.

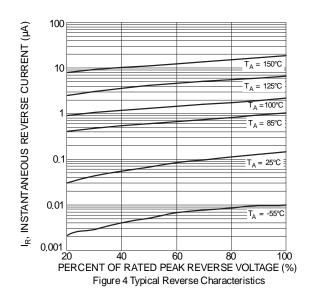
- Measured at 1.0MHz and applied reverse voltage of 4.0V DC.
 Device mounted on FR-4 substrate, 1" * 1", 2oz, single-sided, PC boards with 0.1"*0.15" copper pads.
 Device mounted on FR-4 substrate, 0.4" * 0.5", 2oz, single-sided, PC boards with 0.2"*0.25" copper pads.

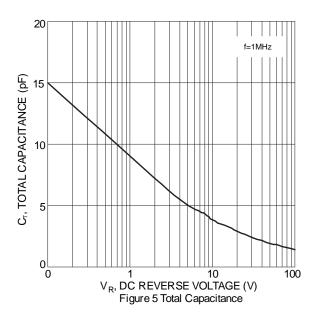


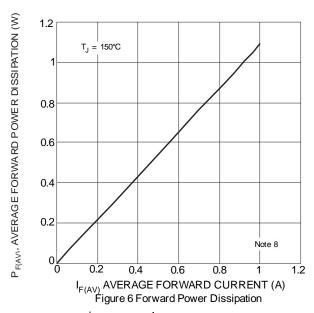


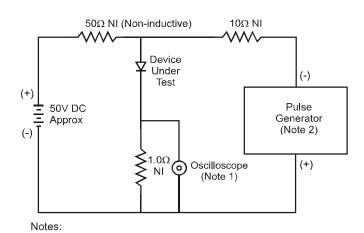


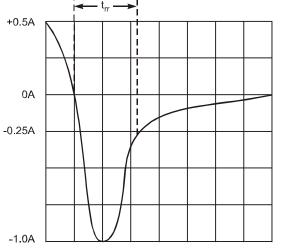












Set time base for 50/100 ns/cm

1. Rise Time = 7.0ns max. Input Impedance = $1.0M\Omega$, 22pF.

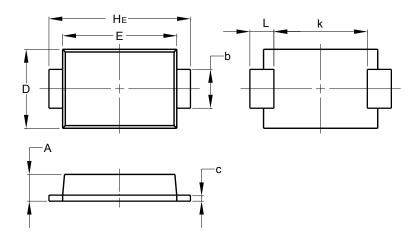
2. Rise Time = 10ns max. Input Impedance = 50Ω .



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

D-FLAT

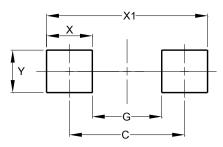


D-FLAT				
Dim	Min	Max		
Α	0.90	1.10		
b	1.25	1.65		
С	0.10	0.40		
D	2.25	2.95		
Е	3.95	4.60		
k	2.80	_		
HE	5.00	5.60		
L	0.50	1.30		
All Dimensions in mm				

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

D-FLAT



Dimensions	Value (in mm)
C	4.65
G	2.80
X	1.85
X1	6.50
Υ	1.70



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